

# LQH44PN150MGRL Datasheet

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DiGi Electronics Part Number	LQH44PN150MGRL-DG
Manufacturer	<a href="#">Murata Electronics</a>
Manufacturer Product Number	LQH44PN150MGRL
Description	FIXED IND 15UH 540MA 504MOHM SMD
Detailed Description	15 $\mu$ H Shielded Drum Core, Wirewound Inductor 540 mA 504mOhm Max 1616 (4040 Metric)



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## Purchase and inquiry

**Manufacturer Product Number:**

LQH44PN150MGRL

**Series:**

LQH44

**Type:**

Drum Core, Wirewound

**Inductance:**15  $\mu$ H**Current Rating (Amps):**

540 mA

**Shielding:**

Shielded

**Q @ Freq:**

-

**Ratings:**

-

**Inductance Frequency - Test:**

1 MHz

**Package / Case:**

1616 (4040 Metric)

**Height - Seated (Max):**

0.039" (1.00mm)

**Manufacturer:**

Murata Electronics

**Product Status:**

Obsolete

**Material - Core:**

Ferrite

**Tolerance:** $\pm$ 20%**Current - Saturation (Isat):**

640mA

**DC Resistance (DCR):**

504mOhm Max

**Frequency - Self Resonant:**

10MHz

**Operating Temperature:**

-40°C ~ 105°C

**Mounting Type:**

Surface Mount

**Size / Dimension:**

0.157" L x 0.157" W (4.00mm x 4.00mm)

**Base Product Number:**

LQH44PN

## Environmental & Export classification

**RoHS Status:**

ROHS3 Compliant

**REACH Status:**

REACH Unaffected

**HTSUS:**

8504.50.8000

**Moisture Sensitivity Level (MSL):**

1 (Unlimited)

**ECCN:**

EAR99

# Inductor for Power Lines (Power Inductor)

# Soldering and Mounting

## 1. Standard Land Pattern Dimensions

A high Q value is achieved when the PCB electrode land pattern is designed so that it does not project beyond the chip inductor (chip coil) electrode.

Land Pattern + Solder Resist  
 Land Pattern  
 Solder Resist  
 (in mm)

Series	Standard Land Dimensions					
LQM18F/18P LQM21D/21F/21P LQM2MP LQM2HP LQM31P LQM32P LQH2MC LQH31C LQH32P LQH44P LQH5BP LQH55D/66S LQW15C_00 LQW15C_10 LQW18C		Part Number	a	b	c	
		LQM18F/18P	Flow	0.7	2.2-2.6	0.7
			Reflow		1.8-2.0	
		LQM21D/21F/21P	1.2	3.0-4.0	1.0	
		LQM2MP	0.8	2.4	1.8	
		LQM2HP	1.6	3.0	1.5	
		LQM31P	2.0	4.2-5.2	1.2	
		LQM32P	1.9	3.6	2.7	
		LQH2MC	0.8	2.6	1.0	
		LQH31C	1.0	4.5	1.5	
		LQH32P	1.3	3.8	2.0	
		LQH44P	1.3	4.4	3.0	
		LQH5BP	1.8	5.5	4.1	
		LQH55D/66S	2.0	8.0	3.5	
		LQW15C_00	0.4	1.4	0.6	
LQW15C_10	0.4	1.4	0.66			
LQW18C	0.7	2.2	1.0			
LQH2HP						
LQH32C						
LQH3NP						
LQH43C LQH43P						
LQH55P						

Attention should be paid to potential magnetic coupling effects when using the inductor (coil) as a resonator.

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## Inductor for Power Lines (Power Inductor) **Soldering and Mounting**

### 2. Standard Soldering Conditions

#### (1) Soldering method

Chip inductor (Chip coils) can be flow or reflow soldered.  
Please contact Murata regarding other soldering methods.  
As for LQH2MC/2HP/3NP/32P/44P/5BP/55D/55P/66S, LQM32P, LQW15C/18C series, please use reflow soldering.

Solder: Use Sn-3.0Ag-0.5Cu solder.

Flux: Use rosin-based flux, but not strongly acidic flux (with chlorine content exceeding 0.2wt%).

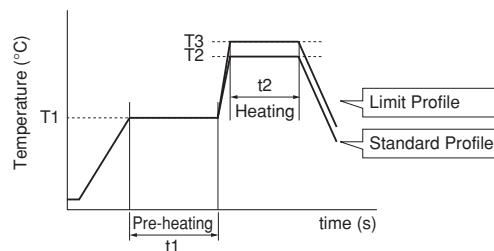
Do not use water-soluble flux.

The flux used for LQW15C/18C series should use the rosin-based flux that includes middle activator equivalent to 0.06wt% to 0.1wt% chlorine.

For additional mounting methods, please contact Murata.

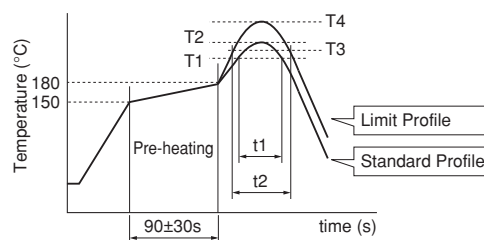
#### (2) Soldering profile

##### ● Flow Soldering profile (Sn-3.0Ag-0.5Cu solder)



Series	Pre-heating		Standard Profile			Limit Profile		
	Temp. (T1)	Time. (t1)	Heating		Cycle of flow	Heating		Cycle of flow
			Temp. (T2)	Time. (t2)		Temp. (T3)	Time. (t2)	
LQM18F/18P LQM21D/21F/21P/2MP/2HP LQM31P LQH31C	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	2 times max.
LQH32C LQH43C/43P	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	1 times

##### ● Reflow Soldering profile (Sn-3.0Ag-0.5Cu solder)



Series	Standard Profile				Limit Profile			
	Heating		Peak temperature (T2)	Cycle of reflow	Heating		Peak temperature (T4)	Cycle of reflow
	Temp. (T1)	Time. (t1)			Temp. (T3)	Time. (t2)		
LQM18F/18P LQM21D/21F/21P/2MP/2HP LQM31P/32P LQH2MC, LQH2HP LQH31C LQH3NP/32P/43P/44P/5BP/55P LQW15C/18C	220°C	30 to 60s	245±3°C	2 times max.	230°C	60s max.	260°C/10s	2 times max.
LQH32C LQH43C LQH55D, LQH66S	220°C	30 to 60s	245±3°C	2 times max.	230°C	60s max.	260°C/10s	1 time

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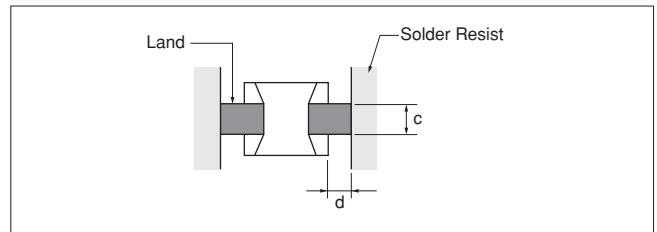
- (3) Reworking with Soldering Iron  
Preheating at 150°C for 1 minute is required. Do not directly touch the ceramic element with the tip of the soldering iron. The reworking soldering conditions are as follows:

Soldering iron power output: 80W max.  
Temperature of soldering iron tip: 350°C  
Diameter of soldering iron end: 3.0mm max.  
Soldering time: within 3 s

### 3. Mounting Instructions

#### (1) Land Pattern Dimensions

Large lands reduce Q of the mounted chip. Also, large protruding land areas (bordered by lines having dimensions 'c' and 'd' shown) cause floating and electrode leaching.

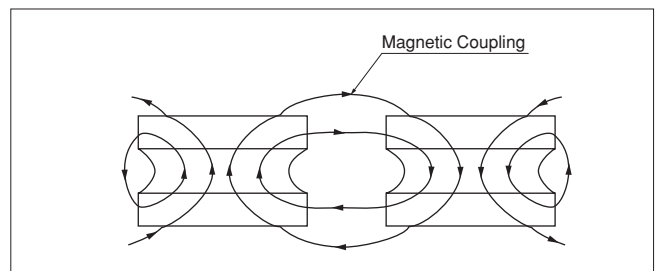


#### (2) Land Pattern Designing (LQH series)

Please follow the recommended patterns. Otherwise, their performance which includes electrical performance or solderability may be affected, or result to "position shift" in soldering process.

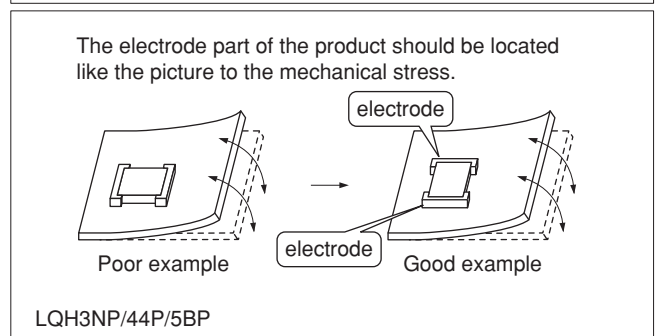
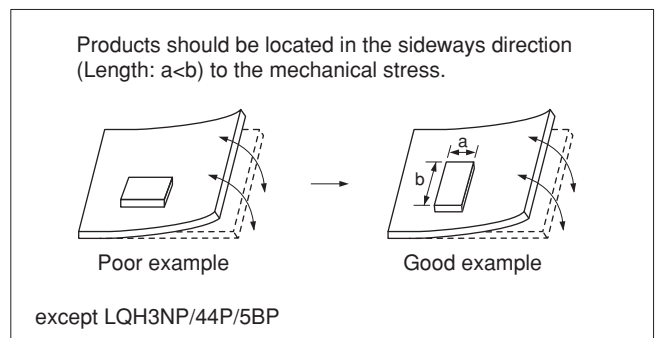
#### (3) Magnetic Coupling

Since some chip inductors (chip coils) are constructed like an open magnetic circuit, narrow spacing between inductors (coils) may cause magnetic coupling. LQM, LQH66S and LQH\_P series have a magnetically shielded structure. The structure makes their coupling coefficient smaller than that of conventional chip inductors (chip coils).



#### (4) PCB Warping

PCB should be designed so that products are not subjected to the mechanical stress caused by warping the board.



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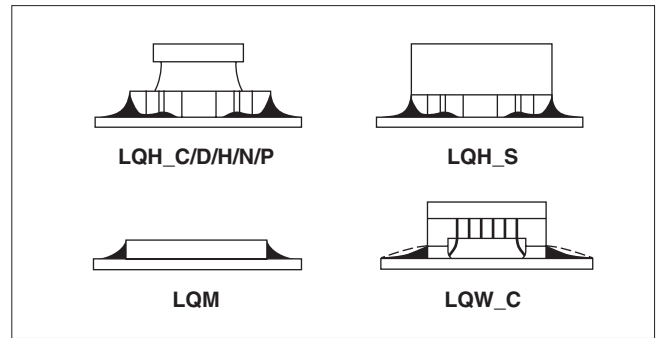
## Inductor for Power Lines (Power Inductor) Soldering and Mounting

### (5) Amount of Solder Paste

Excessive solder causes electrode corrosion, while insufficient solder causes low electrode bonding strength. Adjust the amount of solder paste as shown on the right so that solder is applied.

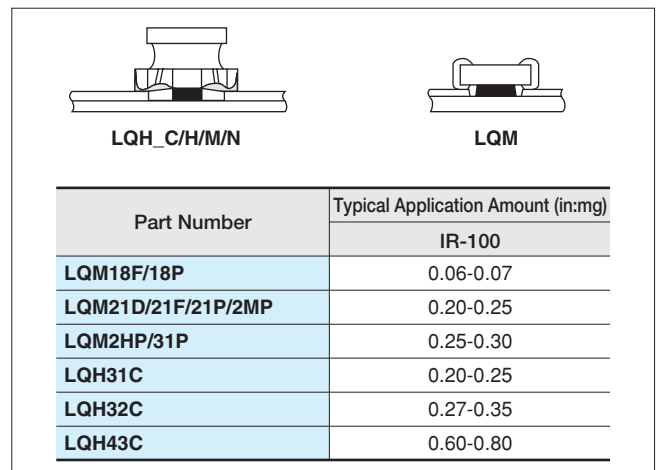
#### ● Guideline of solder paste thickness

- LQW15C: 50 to 100 $\mu$ m
- LQM, LQW18C, LQH2MC/2HP, LQH3NP/32P, LQH44P/5BP/55P: 100 to 150 $\mu$ m
- LQH31C/32C, LQH43C/43P, LQH55D, LQH66S: 200 to 300 $\mu$ m



### (6) Amount of Adhesive

If too much adhesive is applied, then it may overflow into the land or termination areas and yield poor solderability. In contrast, if insufficient adhesive is applied, or if the adhesive is not sufficiently hardened, then the chip may become detached during flow soldering. Apply the adhesive in accordance with the conditions shown in chart.



## 4. Cleaning

The following conditions should be observed when cleaning chip inductors (chip coils):

- (1) Cleaning Temperature: 60°C max. (40°C max. for alcohol cleaning agents)
- (2) Ultrasonic
  - Output: 20W/l max.
  - Duration: 5 minutes max.
  - Frequency: 28 to 40kHz
  - Care should be taken not to cause resonance of the PCB and mounted products.
- (3) Cleaning agent
 

The following cleaning agents have been tested on individual components. Evaluation in complete assembly should be done prior to production.

  - (a) Alcohol cleaning agents
    - Isopropyl alcohol (IPA)
  - (b) Aqueous cleaning agents
    - Pine Alpha ST-100S
    - LQH66S series: Aqueous agents should not be used because they may cause quality deterioration or damage to appearance.

- (4) Ensure that flux residue is completely removed. Component should be thoroughly dried after aqueous agents have been removed with deionized water.

For additional cleaning methods, please contact Murata.



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